

IN THE SPECIFICATION:

Please rewrite the paragraph at page 14, lines 2-15 as follows:

The mixing ratio of the constituents of the adhesive layer 32, the ionizing radiation curable resin and the heat-reactive resin, is preferably 50-200 ~~5-200~~ weight parts of the heat-reactive resin with regard to 100 weight parts of ionizing radiation curable resin. When the heat-reactive resin is not less than 50 weight parts, the adhesive layer is not pressed out during the adhering step and high adhesiveness to the image surface of photo masks can be achieved. Thereby, workability is improved. When the heat-reactive resin is not more than 200 weight parts, sufficient hardness can be brought to the adhesive layer 32 after it is exposed to ionizing radiation, and mar resistance and resistance to solvents of the protective layer 3 are also improved.